

Quarterly Reliability Monitoring Results

Quarters: Q1/2022 to Q4/2023

Based on structural similarity

		Supplier				
BZX84-C22-Q					Nexperia B.V.	
		Name of Laboratory				
			Nexperia DHAM Zener			
			Assembly reliability labs			
# Rejects	# Quantity	# Lots	Duration	Test Conditions	C-Q101 Test	Based on AE
					TEST	
					Pre- and Post-Stress	
see below	all parts	see below	N/A	Tamb = 25 °C	Electrical Test	# E1
				JESD22-A113		
			24 hours	Bake Tamb = 125 °C		
			168 hours	Soak Tamb = 85 °C, RH = 85%	PC	
0	64430	1514	3 cycles	Reflow soldering	Preconditioning	# A1
				MIL-STD-750-1		
				M1038 Method A	HTRB	
				Tj = Tjmax, VR = 80 % of rated reverse	,	
0	11400	250	1000 hours	voltage	Bias	# B1
				MIL-STD-750-1		
				M1038 Method B		
				Tj = Tjmax, Iz = 100% of max. datasheet	SSOP	
0	1920	44	1000 hours	reverse current	Steady State Operational	# B1b
				JESD22-A104	тс	
0	14080	311	1000 cycles	-65 °C to Tjmax, not to exceed 150°C	Temperature Cycling	# A4
				150000 4440		
				JESD22-A118	UHAST Unbiased HAST	# A3 or
0	14080	311	- 96 hours	Tamb = 130 °C, RH = 85 %	Ulibiased HAS I	# A3 O F
				JESD22-A102		
				Tamb = 121 °C, RH = 100 %	AC	
				Pressure = 205 kPa (29.7 psia)	Autoclave	# A3 alt
				JESD22-A101	HOTOD	
				Tamb = 85 °C, RH = 85%, VR = 80 % of	H3TRB	
0	1.4000	211	1000	rated reverse voltage ^[1]	High Humidity High	# A2 - It
0	14080	311	1000 hours		Temperature Reverse Bias	# A2 alt
				MIL-STD-750 Method 1037	101	
0	14120	212	1000	, .		# A F
0	14120	312	1000 nours	100 °C for 15000 cycles	Intermittent Operating Life	# A5
				IFSD22-Δ111	RSH	
0	8070	269	10 c			# C8
<u> </u>	0070	203	10.5	200 0 = 0 0		# C0
0	6660	19		1-STD-002		# C10
_	14120 8070 6660	312 269 19	1000 hours	ton = toff, devices powered to insure ΔTj = 100 °C for 15000 cycles JESD22-A111	IOL Intermittent Operating Life RSH Resistance to Solder Heat SD Solderability	# A5 # C8 # C10

^[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
Nexperia					
DHAM	Zener	11400	0	0,37	2,68E+09

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